

20V COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

| Device | V _{(BR)DSS} | R _{DS(on)} max | I _D max T _A = 25°C (Notes 4) |
|--------|----------------------|--------------------------------|--|
| Q1 | 04 201/ | 0.4Ω @ V _{GS} = 4.5V | 1.34 A |
| QI | 20V | 0.5Ω @ V _{GS} = 2.5V | 1.65 A |
| 00 | 001/ | 0.7Ω @ V _{GS} = -4.5V | -1.14 A |
| Q2 | -20V | 0.9Ω @ V _{GS} = -2.5V | -0.94 A |

Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.015 grams (approximate)

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage V_{GS(th)} < 1V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Gate to 2.5kV HBM
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

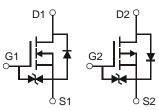
Portable electronics



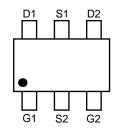


SOT26









Top view Pin-Out

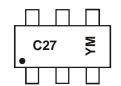
Ordering Information (Note 3)

| Product | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|--------------|---------|--------------------|-----------------|-------------------|
| DMC2700UDM-7 | C27 | 7 | 8 | 3,000 |

Notes:

- 1. No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com
 For packaging details, go to our website at http://www.diodes.com

Marking Information



C27 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009)M = Month (ex: 9 = September)

Date Code Key

| Year | 200 | 9 | 2010 | | 2011 | 20 | 12 | 2013 | | 2014 | | 2015 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code | W | | Χ | | Υ | 7 | 7 | Α | | В | | С |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |





Maximum Ratings N-CHANNEL − Q₁ @T_A = 25°C unless other wise specified

| Characteris | Symbol | Value | Unit | |
|------------------------|--|----------------|--------------|---|
| Drain Source Voltage | V_{DSS} | 20 | V | |
| Gate-Source Voltage | V_{GSS} | ±6 | V | |
| Drain Current (Note 4) | T _A = 25°C T _A = 85°C | I _D | 1.34 0.97 | А |

Maximum Ratings P-CHANNEL – Q_2 @ $T_A = 25$ °C unless oth erwise specified

| Characterist | Symbol | Value | Unit | |
|------------------------|--------------------------------|----------------|----------------|---|
| Drain Source Voltage | V_{DSS} | -20 | V | |
| Gate-Source Voltage | V _{GSS} | ±6 | V | |
| Drain Current (Note 4) | $T_A = 25$ °C $T_A = 85$ °C | I _D | -1.14 -1.07 | А |

Thermal Characteristics @TA = 25°C unless other wise specified

| Characteristic | Symbol | Value | Unit |
|--|-------------------|-------------|------|
| Power Dissipation (Note 4) | P_{D} | 1.12 | W |
| Thermal Resistance, Junction to Ambient (Note 4) | $R_{	hetaJA}$ | 111 | °C/W |
| Operating and Storage Temperature Range | T_J , T_{STG} | -55 to +150 | °C |

Notes: 4. For a device mounted on 25mm X 25mm FR-4 PCB board with a high coverage of single sided 1oz copper, in still air conditions with two active die



Electrical Characteristics N-CHANNEL - Q₁ @T_A = 25°C unless other wise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-----------------------------------|----------------------|-----|-------|-------|------|--|
| OFF CHARACTERISTICS (Note 5) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 20 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 100 | nA | $V_{DS} = 20V, V_{GS} = 0V$ |
| Gate-Source Leakage | Igss | _ | _ | ± 1.0 | μΑ | $V_{GS} = \pm 4.5V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 5) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.5 | _ | 1.0 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ |
| | | _ | 0.3 | 0.4 | | $V_{GS} = 4.5V, I_D = 600mA$ |
| Static Drain-Source On-Resistance | R _{DS} (ON) | _ | 0.4 | 0.5 | Ω | $V_{GS} = 2.5V, I_D = 500mA$ |
| | | _ | 0.5 | 0.7 | | $V_{GS} = 1.8V, I_D = 350mA$ |
| Forward Transfer Admittance | Y _{fs} | _ | 1.4 | _ | S | $V_{DS} = 10V, I_D = 400 \text{mA}$ |
| Diode Forward Voltage (Note 5) | V_{SD} | _ | 0.7 | 1.2 | V | $V_{GS} = 0V, I_{S} = 150mA$ |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C _{iss} | _ | 60.67 | _ | pF | 1/ 101/1/ 01/ |
| Output Capacitance | Coss | _ | 9.68 | _ | pF | $V_{DS} = 16V, V_{GS} = 0V$ -f = 1.0MHz |
| Reverse Transfer Capacitance | C _{rss} | _ | 5.37 | _ | pF | 1 = 1.000112 |
| Total Gate Charge | Qg | _ | 736.6 | _ | | V 45V V 40V |
| Gate-Source Charge | Q_{gs} | _ | 93.6 | _ | рC | $V_{GS} = 4.5V, V_{DS} = 10V,$ |
| Gate-Drain Charge | Q_{gd} | _ | 116.6 | _ | | $I_D = 250 \text{mA}$ |
| Turn-On Delay Time | t _{d(on)} | _ | 5.1 | _ | | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ |
| Turn-On Rise Time | t _r | | 7.4 | | nc | $V_{DD} = 10V, V_{GS} = 4.5V,$ |
| Turn-Off Delay Time | t _{d(off)} | | 26.7 | _ | ns | $R_L = 47\Omega$, $R_G = 10\Omega$, $I_D = 200$ mA |
| Turn-Off Fall Time | t _f | | 12.3 | _ | | 10 - 200111A |

Electrical Characteristics P-CHANNEL – $\mathbf{Q_2}$ @T_A = 25°C unless other wise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-----------------------------------|----------------------|------|-------|-------|------|--|
| OFF CHARACTERISTICS (Note 5) | | | | | | • |
| Drain-Source Breakdown Voltage | BV _{DSS} | -20 | _ | _ | V | $V_{GS} = 0V, I_D = -250\mu A$ |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | -100 | nA | V _{DS} = -20V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | _ | _ | ± 1.0 | μΑ | $V_{GS} = \pm 4.5 V, V_{DS} = 0 V$ |
| ON CHARACTERISTICS (Note 5) | | | | | _ | |
| Gate Threshold Voltage | V _{GS(th)} | -0.5 | | -1.0 | V | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ |
| | | | 0.5 | 0.7 | | $V_{GS} = -4.5V$, $I_D = -430mA$ |
| Static Drain-Source On-Resistance | R _{DS (ON)} | _ | 0.7 | 0.9 | Ω | $V_{GS} = -2.5V, I_D = -300mA$ |
| | | | 1.0 | 1.3 | | $V_{GS} = -1.8V, I_D = -150mA$ |
| Forward Transfer Admittance | Y _{fs} | _ | -0.9 | _ | S | $V_{DS} = 10V, I_{D} = -250mA$ |
| Diode Forward Voltage (Note 5) | V_{SD} | _ | -0.8 | -1.2 | V | $V_{GS} = 0V, I_{S} = -150mA$ |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C _{iss} | _ | 59.76 | _ | pF | 101/11/ |
| Output Capacitance | Coss | _ | 12.07 | _ | pF | $V_{DS} = -16V, V_{GS} = 0V$ - $f = 1.0MHz$ |
| Reverse Transfer Capacitance | C _{rss} | _ | 6.36 | _ | pF | T = 1.0MH2 |
| Total Gate Charge | Qq | _ | 622.4 | _ | | 151/1/ 101/ |
| Gate-Source Charge | Qgs | _ | 100.3 | _ | рC | $V_{GS} = -4.5V, V_{DS} = -10V,$ |
| Gate-Drain Charge | Q _{gd} | _ | 132.2 | _ | | $I_D = -250 \text{mA}$ |
| Turn-On Delay Time | t _{d(on)} | _ | 5.1 | _ | | |
| Turn-On Rise Time | t _r | _ | 8.1 | _ | 1 | $V_{DD} = -10V, V_{GS} = -4.5V,$ |
| Turn-Off Delay Time | t _{d(off)} | _ | 28.4 | _ | ns | $R_L = 47\Omega$, $R_G = 10\Omega$, |
| Turn-Off Fall Time | t _f | _ | 20.7 | _ | 1 | $I_D = -200 \text{mA}$ |

Notes: 5. Short duration pulse test used to minimize self-heating effect.



T_A = 85°C

T_A = 150° C T_A = 125° C

T_A = 85°C

 $T_A = 25^{\circ}C$

T_A = -55°C

8.0

1.0

0.6

50

T_A, AMBIENT TEMPERATURE (°C)

Fig. 6 On-Resistance Variation with Temperature

75

100

2

N-CHANNEL - Q1

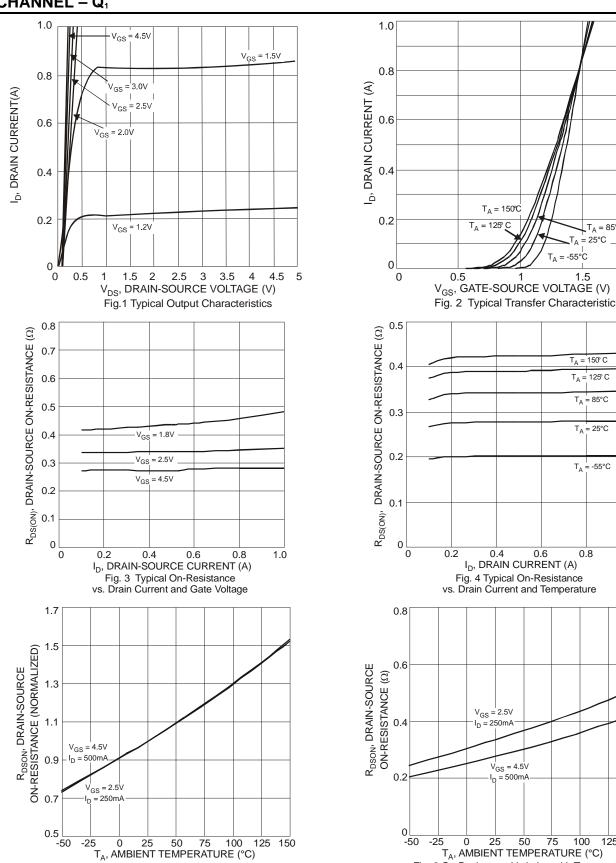


Fig. 5 On-Resistance Variation with Temperature

125 150



N-CHANNEL - Q₁ (continued)

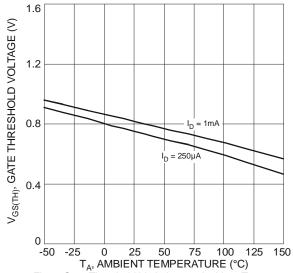
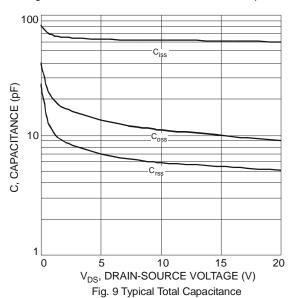
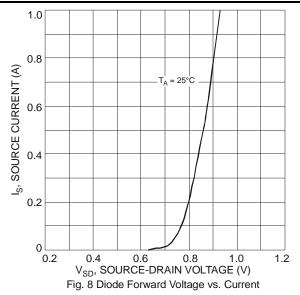


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





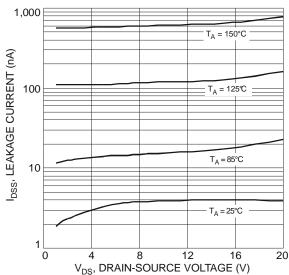
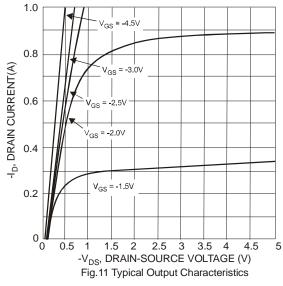
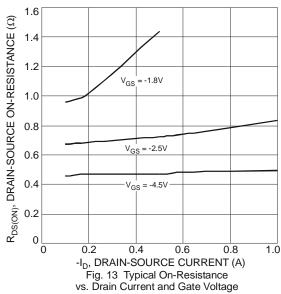


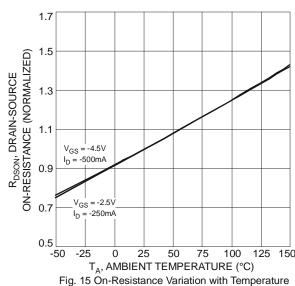
Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

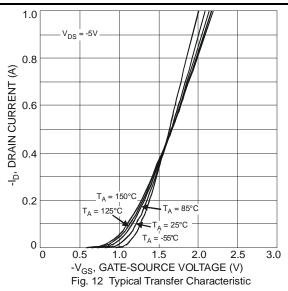


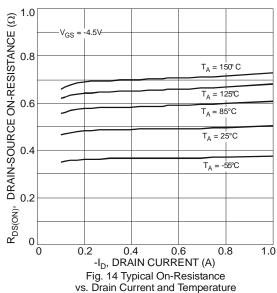
P-CHANNEL - Q₂











1.0 $R_{DSON},$ DRAIN-SOURCE ON-RESISTANCE (Ω) 0.8 $V_{GS} = -2.5\dot{V}$ = -250mA $V_{GS} = -4.5V$ I_D = -500mA 0.2 0 25 50 75 100 T_A, AMBIENT TEMPERATURE (°C)

Fig. 16 On-Resistance Variation with Temperature



P-CHANNEL - Q₂ (continued)

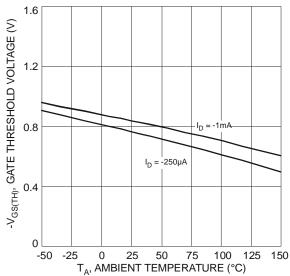
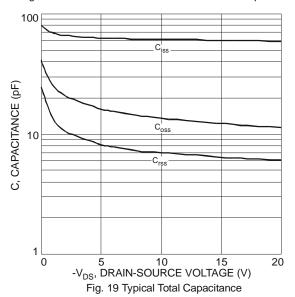
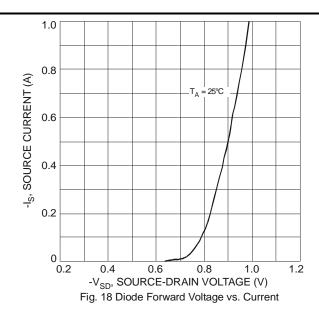
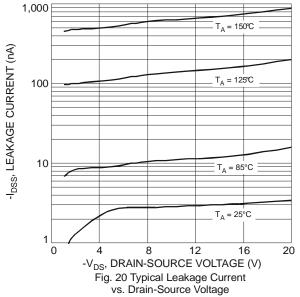


Fig. 17 Gate Threshold Variation vs. Ambient Temperature

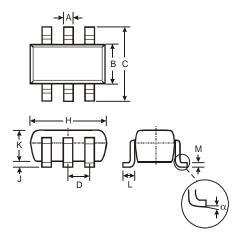






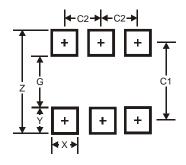


Package Outline Dimensions



| | SOT | - 26 | | | |
|-------|----------------------|-------------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.35 | 0.50 | 0.38 | | |
| В | 1.50 | 1.70 | 1.60 | | |
| С | 2.70 | 3.00 | 2.80 | | |
| D | _ | _ | 0.95 | | |
| Н | 2.90 | 3.10 | 3.00 | | |
| J | 0.013 | 0.10 | 0.05 | | |
| K | 1.00 | 1.30 | 1.10 | | |
| L | 0.35 | 0.55 | 0.40 | | |
| М | 0.10 | 0.20 | 0.15 | | |
| α | 0° | 8° | _ | | |
| All D | All Dimensions in mm | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 3.20 |
| G | 1.60 |
| Х | 0.55 |
| Y | 0.80 |
| C1 | 2.40 |
| C2 | 0.95 |





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